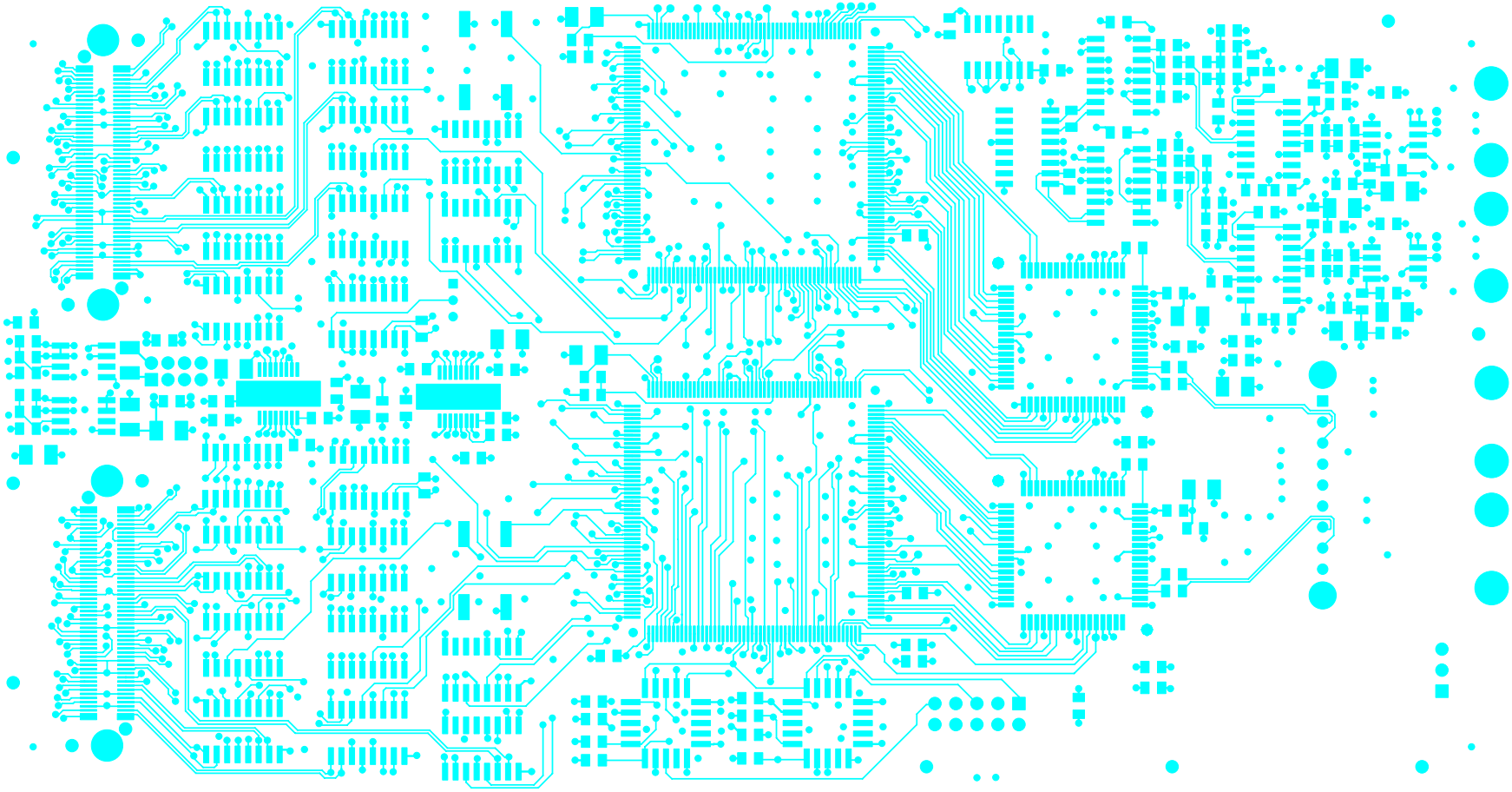
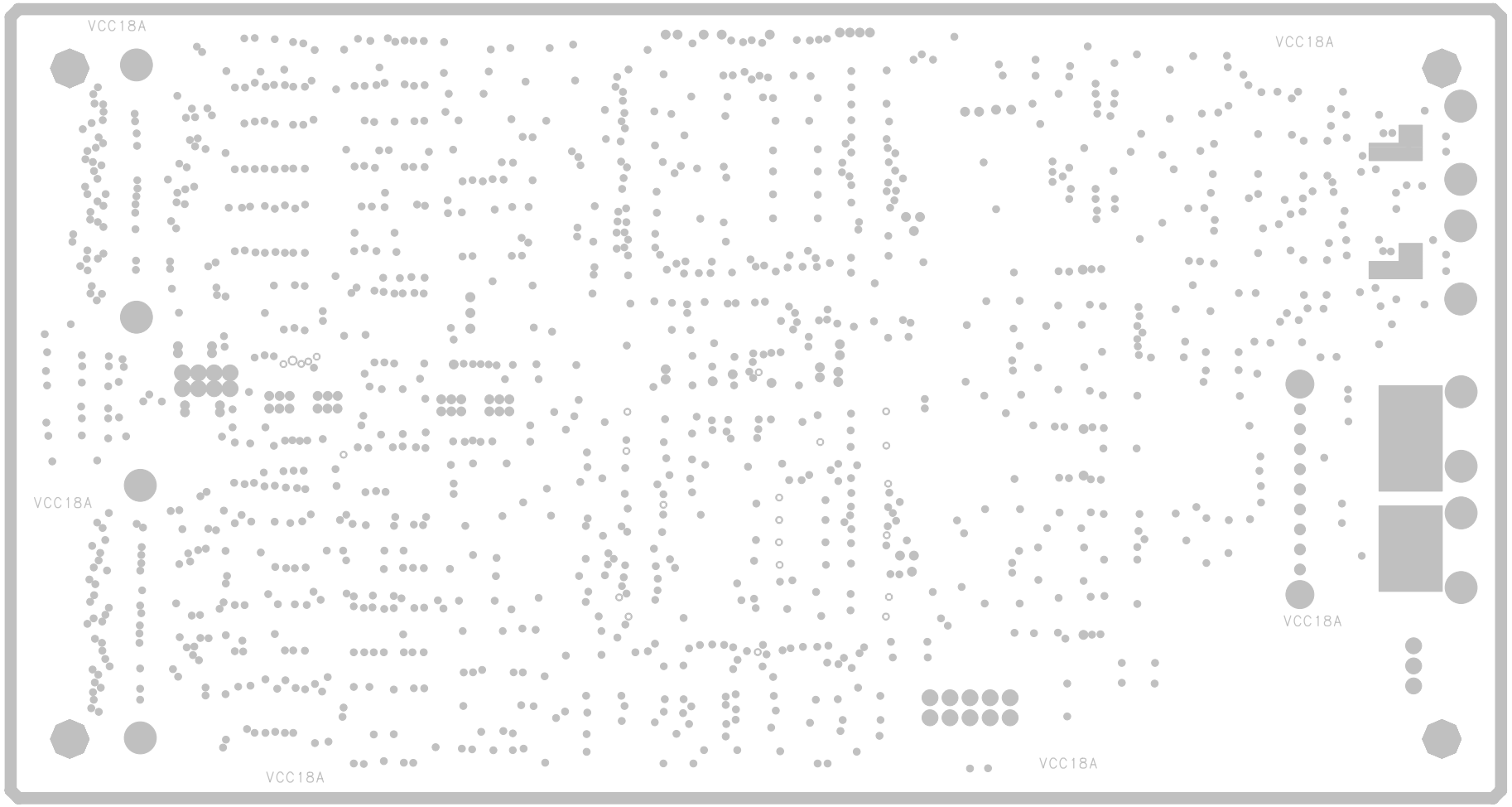
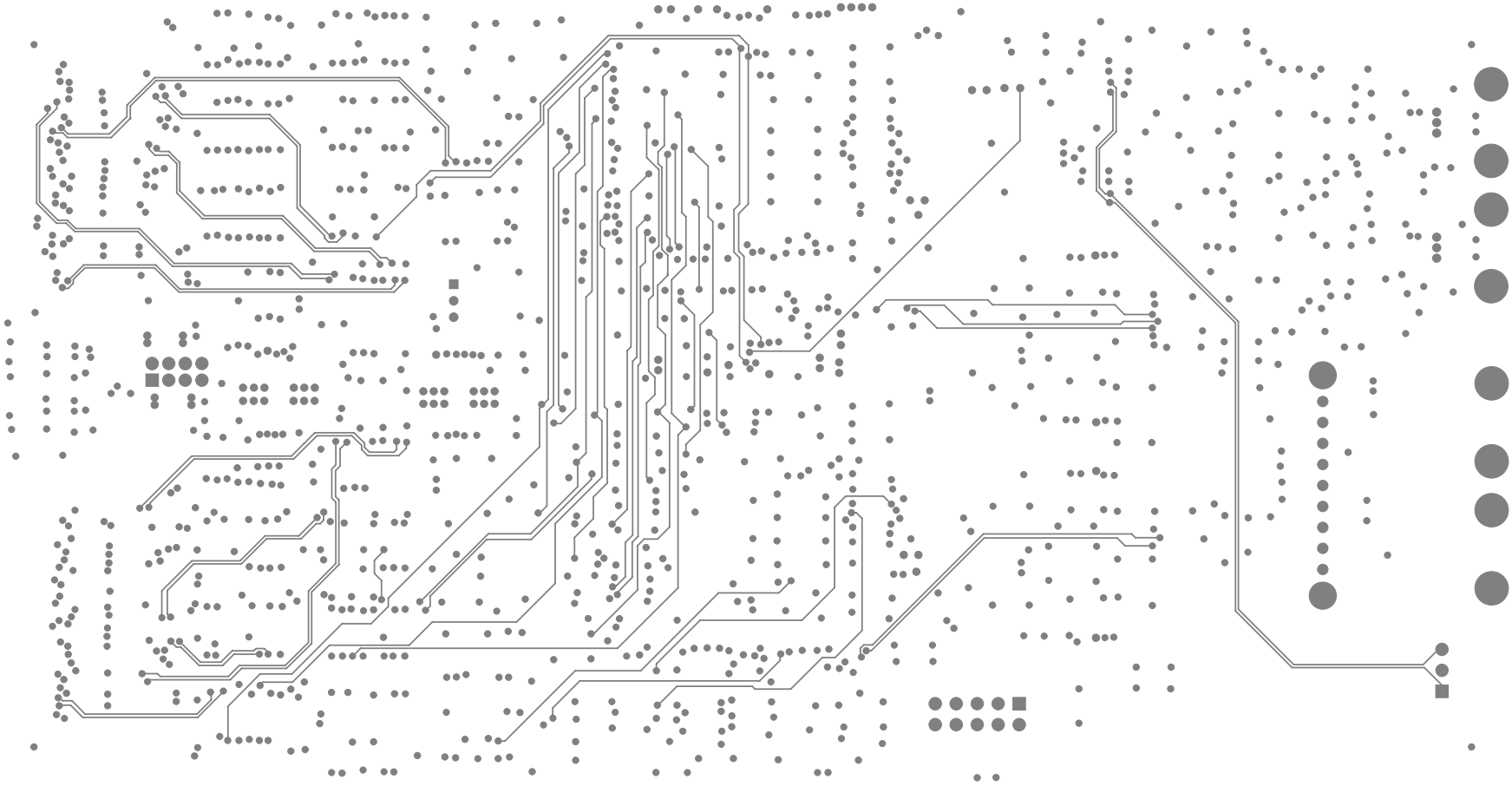


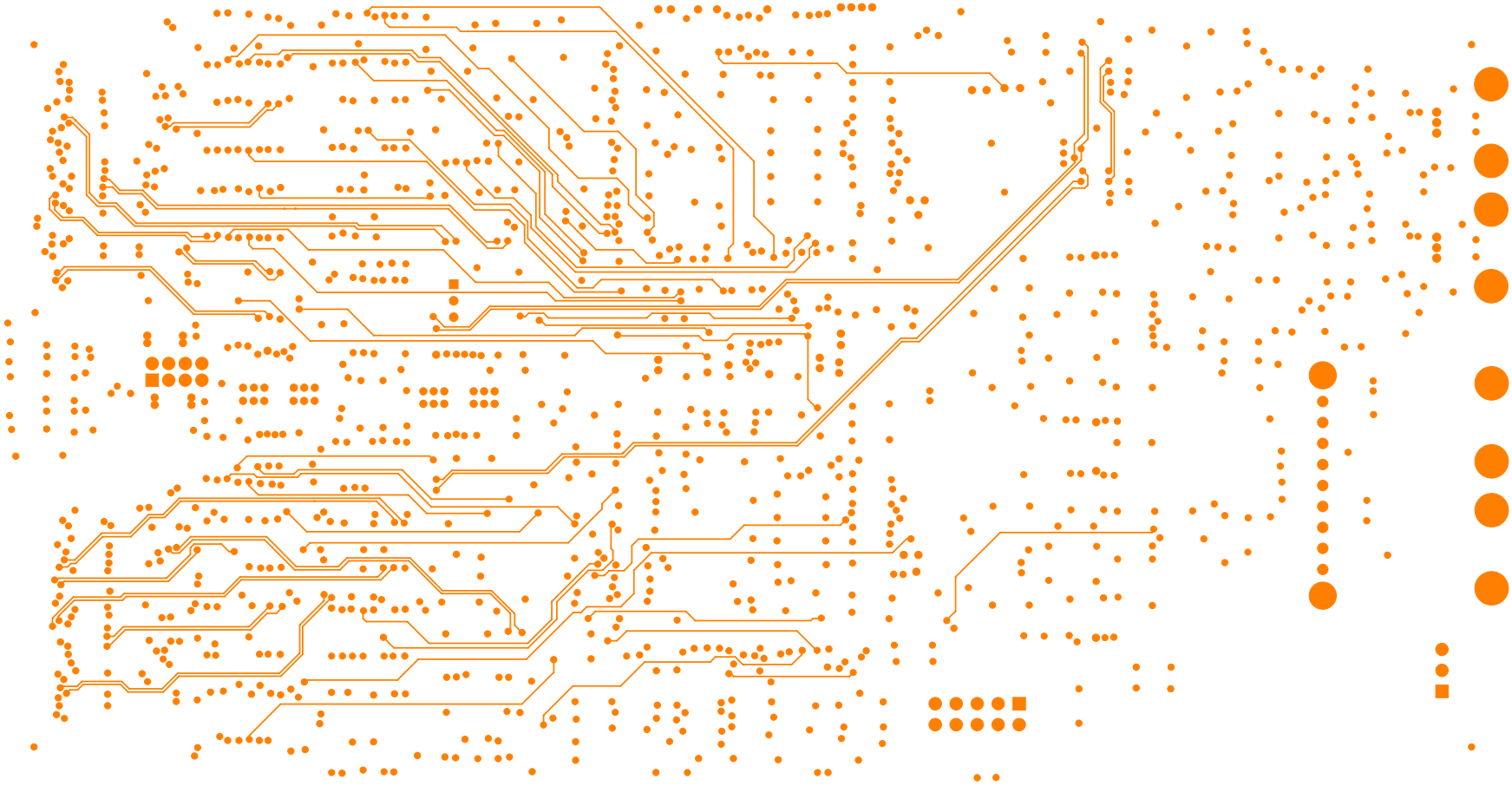
Artwork_1: Top Component layer (SIGNAL_1)



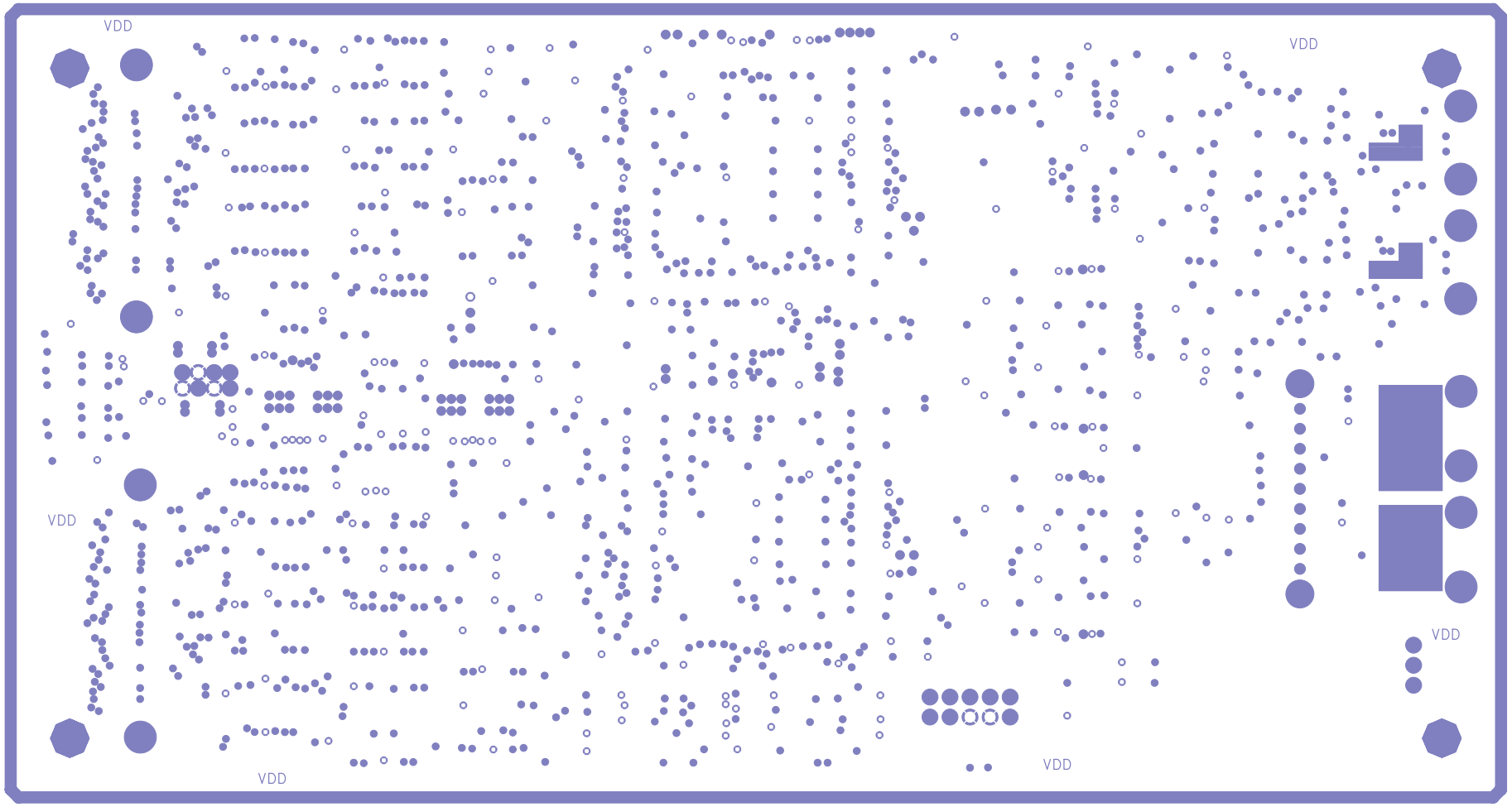
Artwork_2: Power_2 (VCC18A)



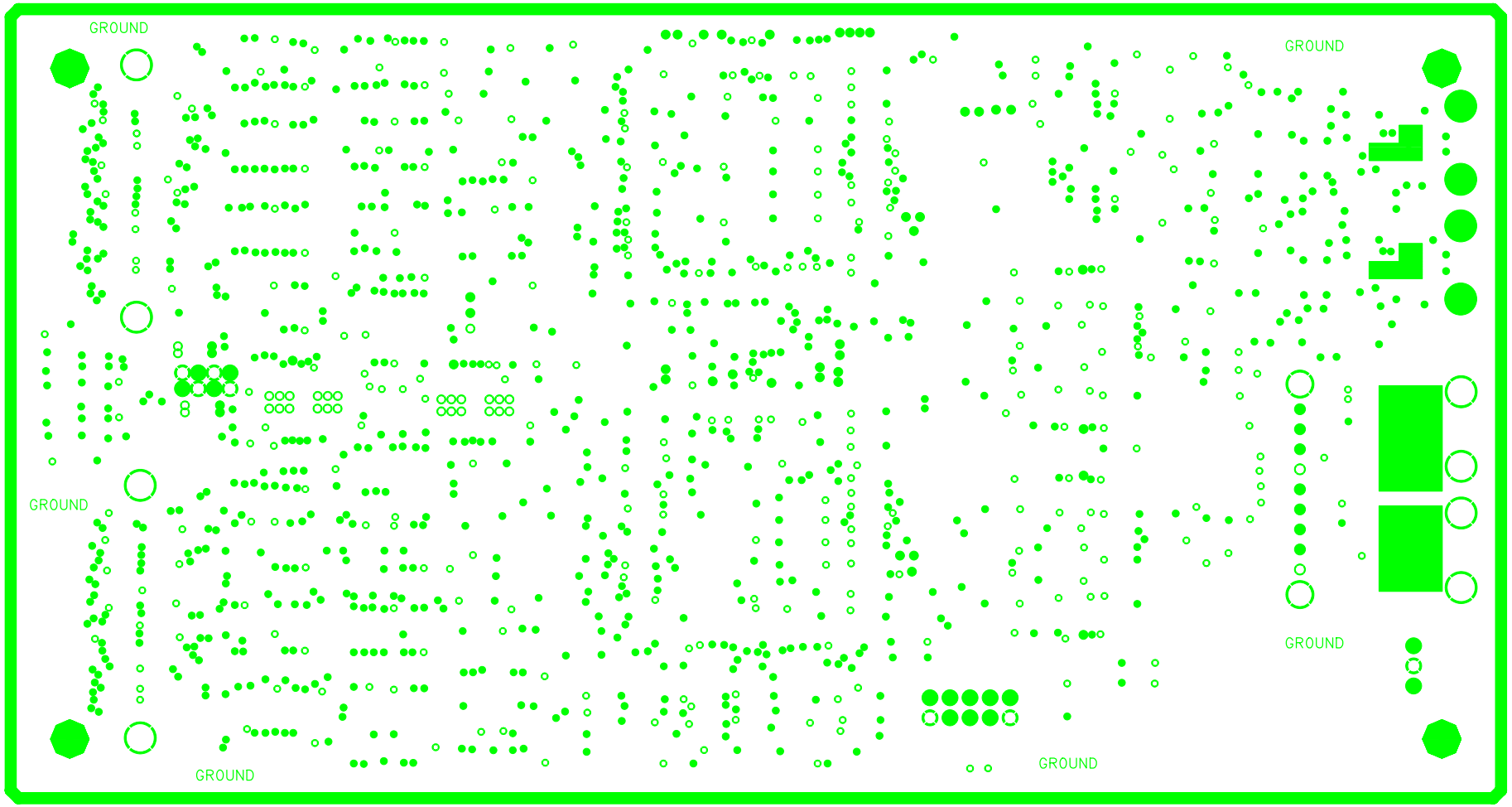
Artwork_3: Inner Signal layer (SIGNAL_2)



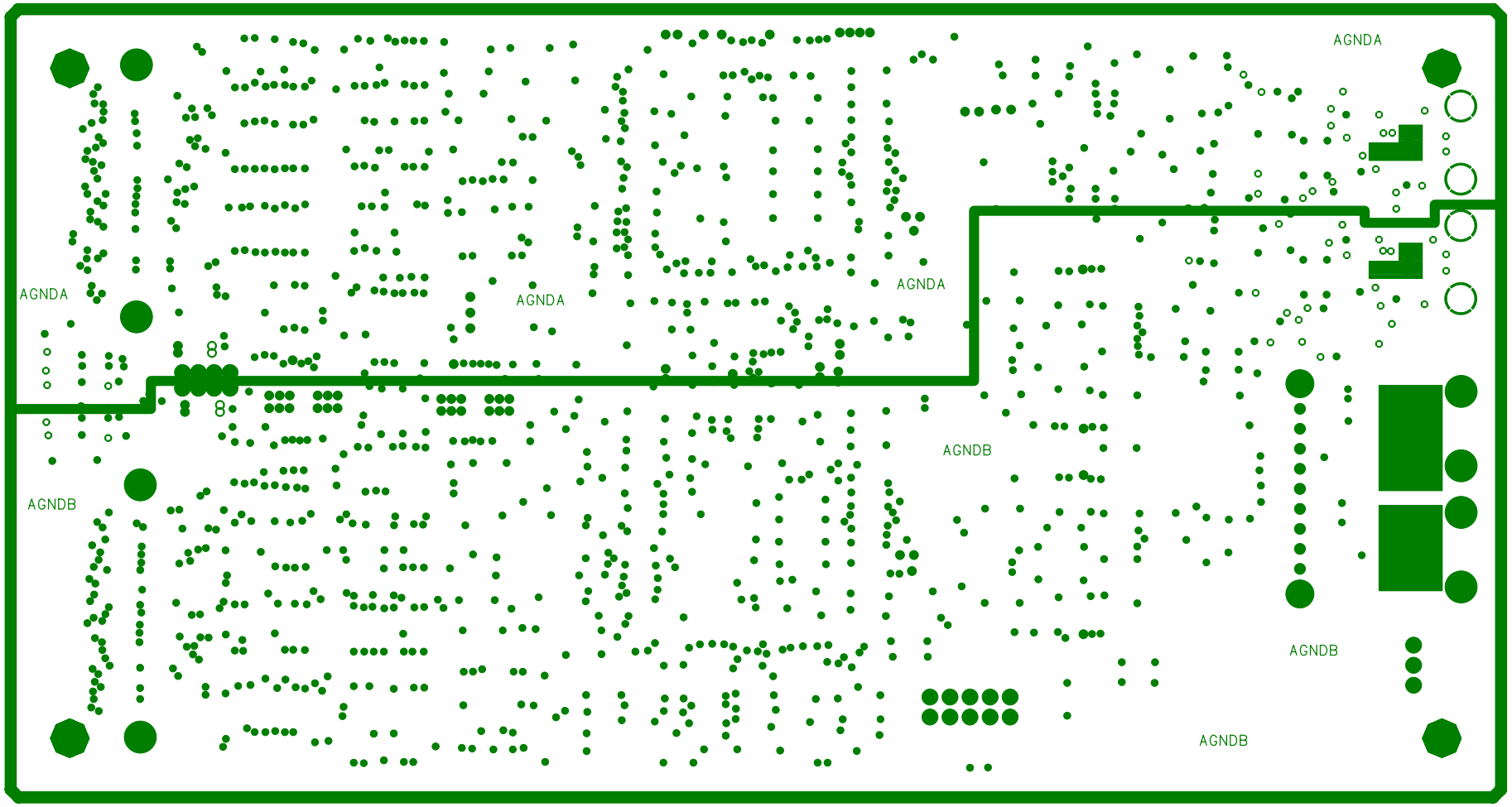
Artwork_4: Inner Signal Layer (SIGNAL_3)



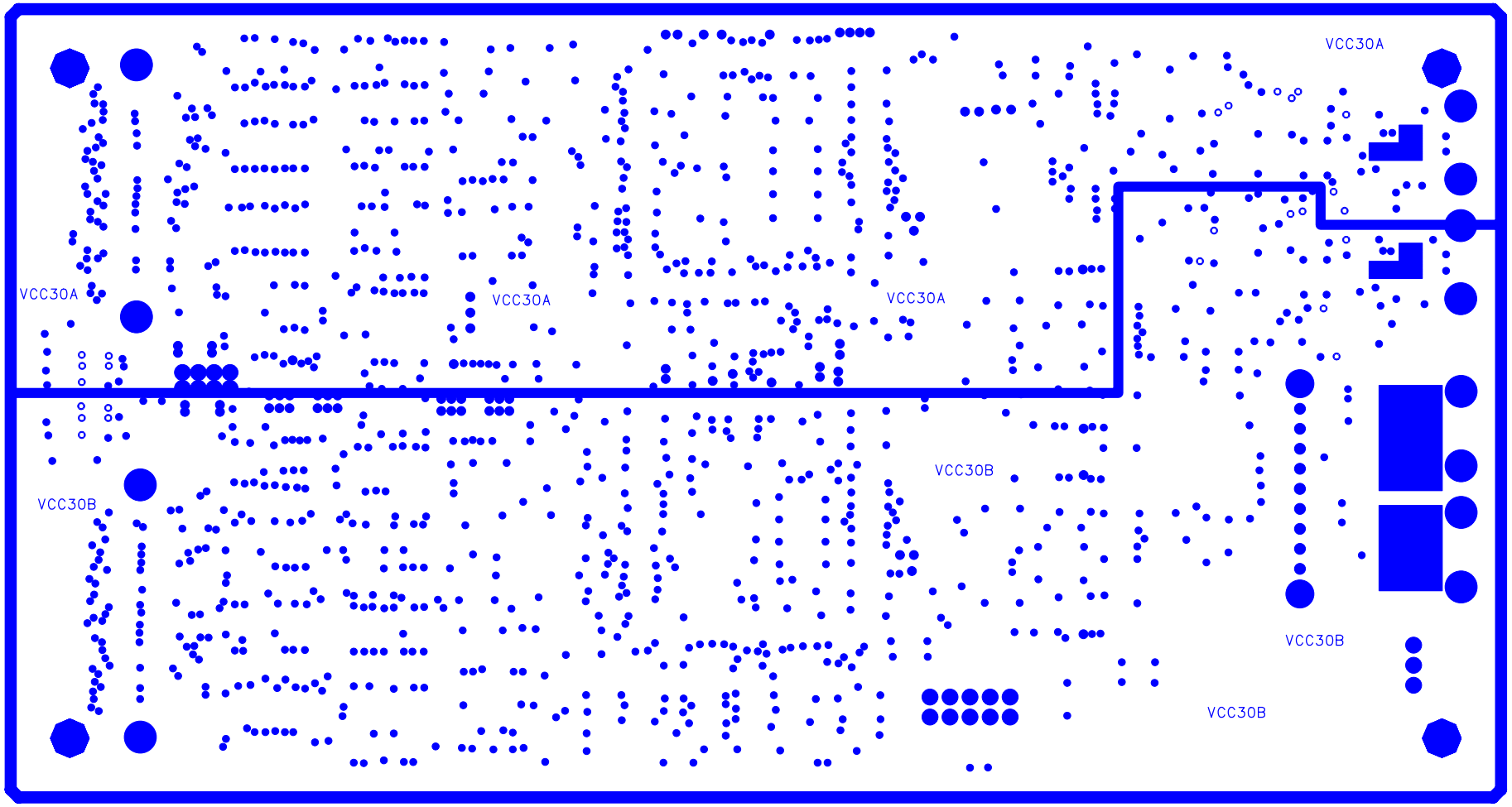
Artwork_5: Power_4(VDD)



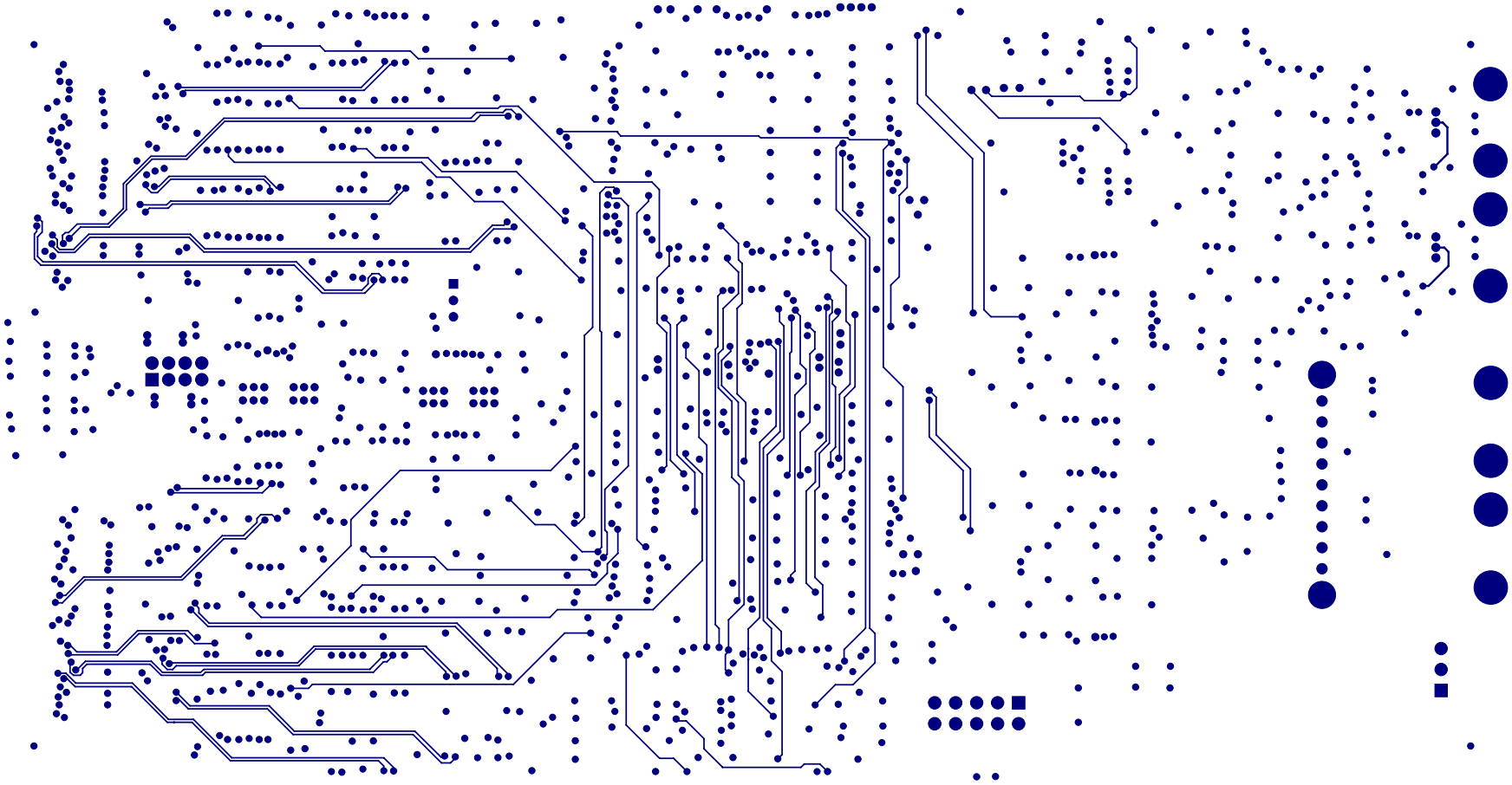
Artwork_6: Power_1 (Ground)



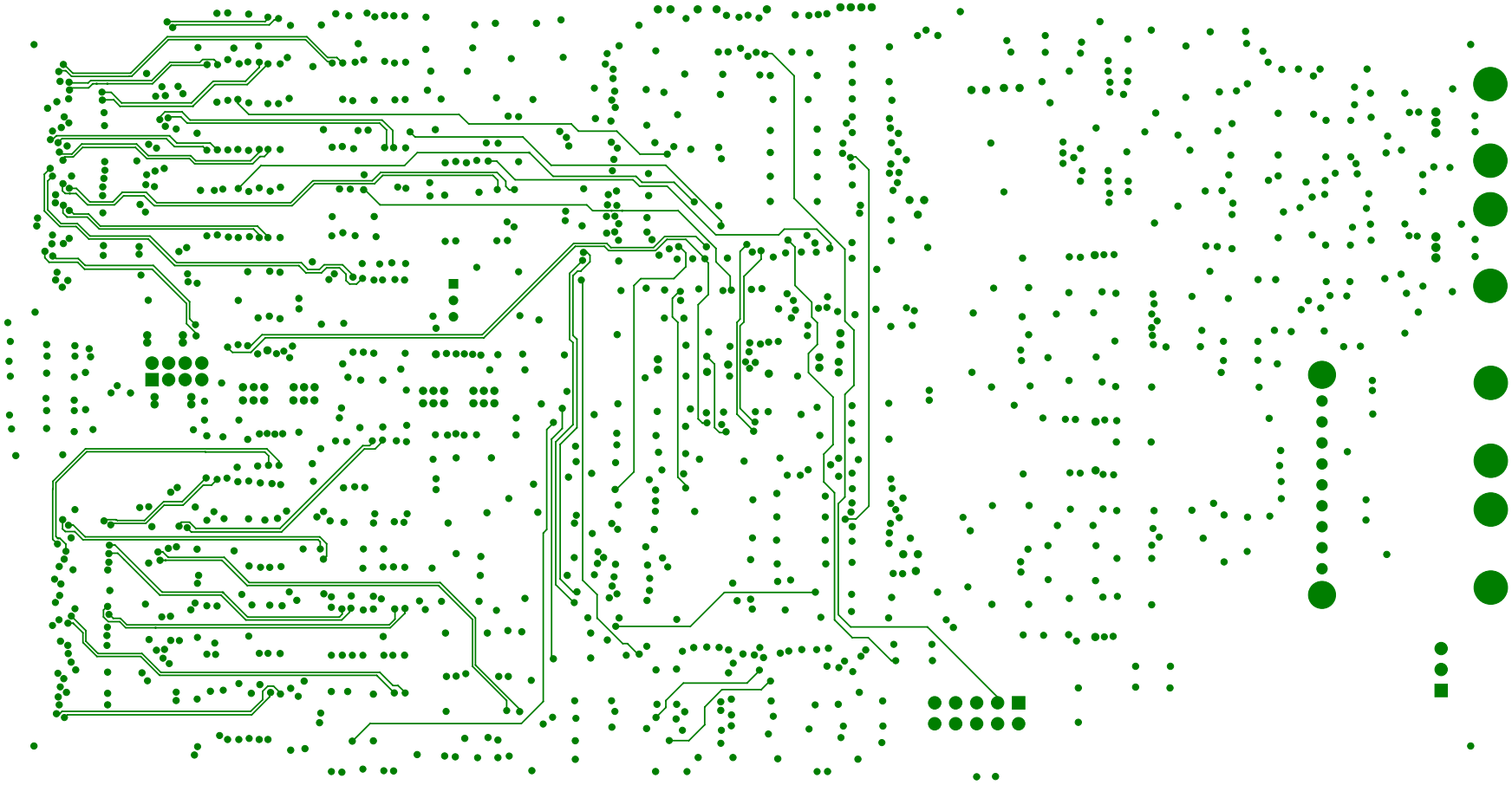
Artwork_7: Splited power plane(AGNDA, AGNDB)



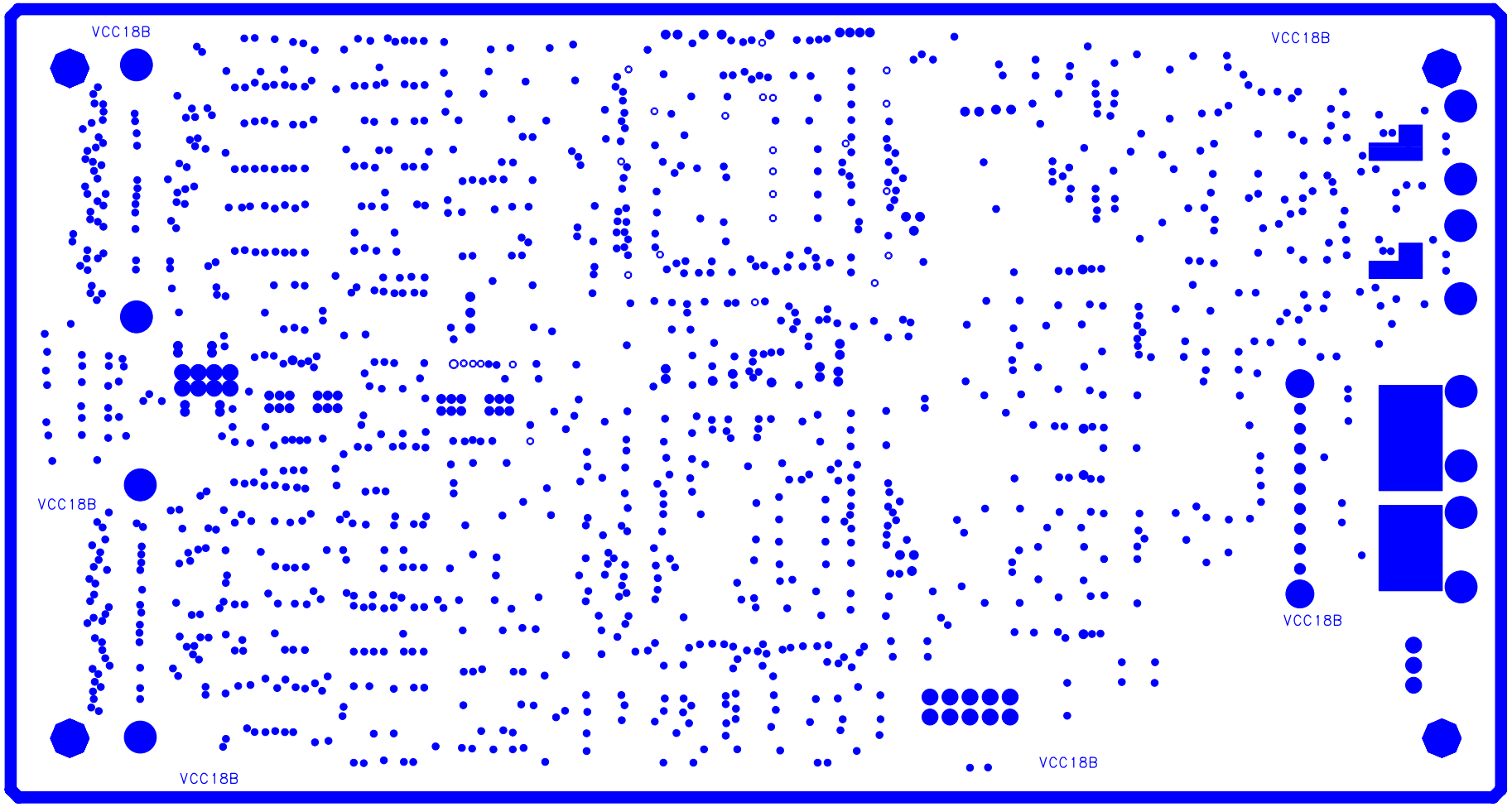
Artwork_8: Splited power plane(VCC30A, VCC30B)



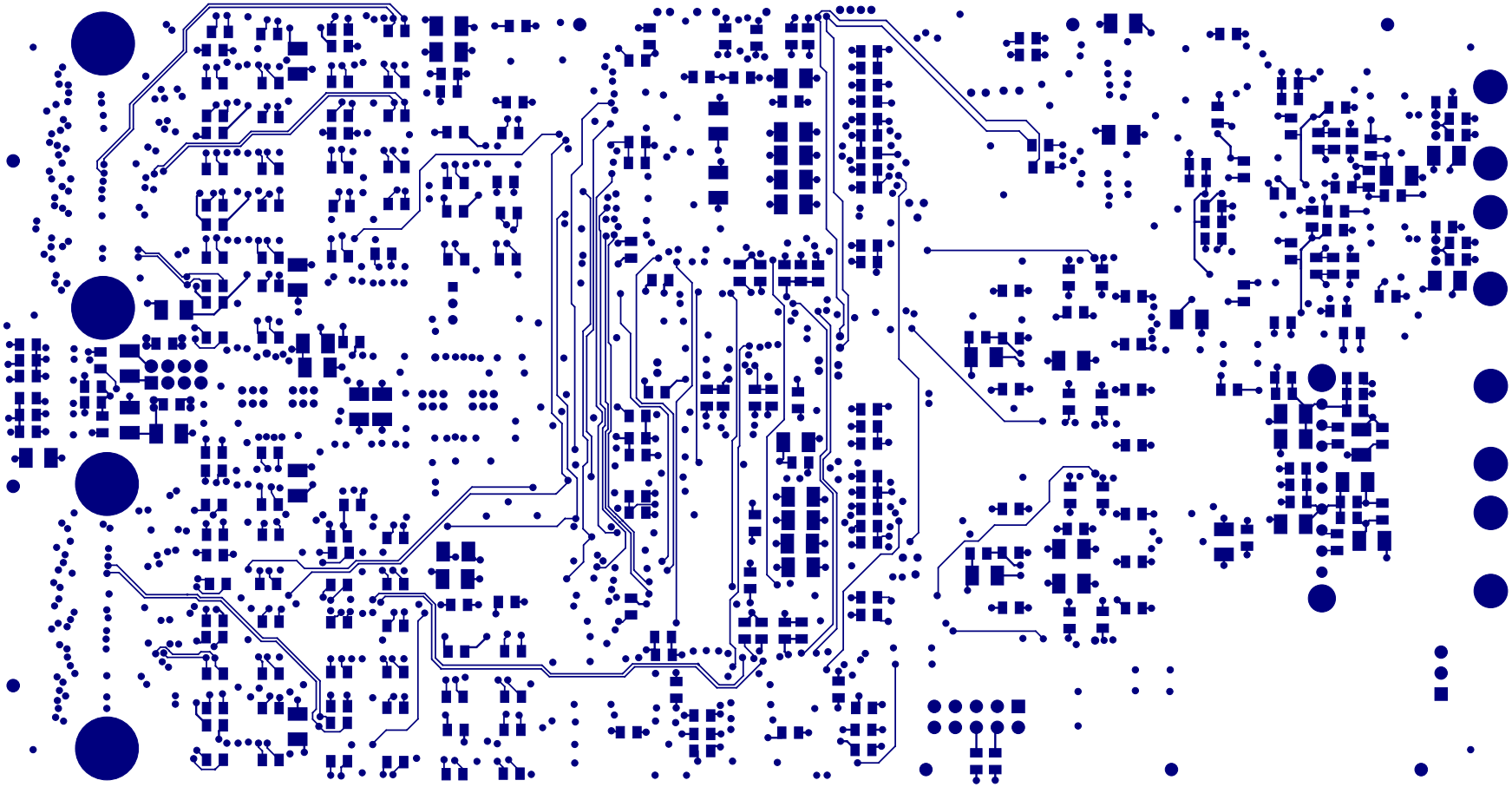
Artwork_9: Inner Signal Layer(SIGNAL_4)



Artwork_10: Inner Signal layer (SIGNAL_5)

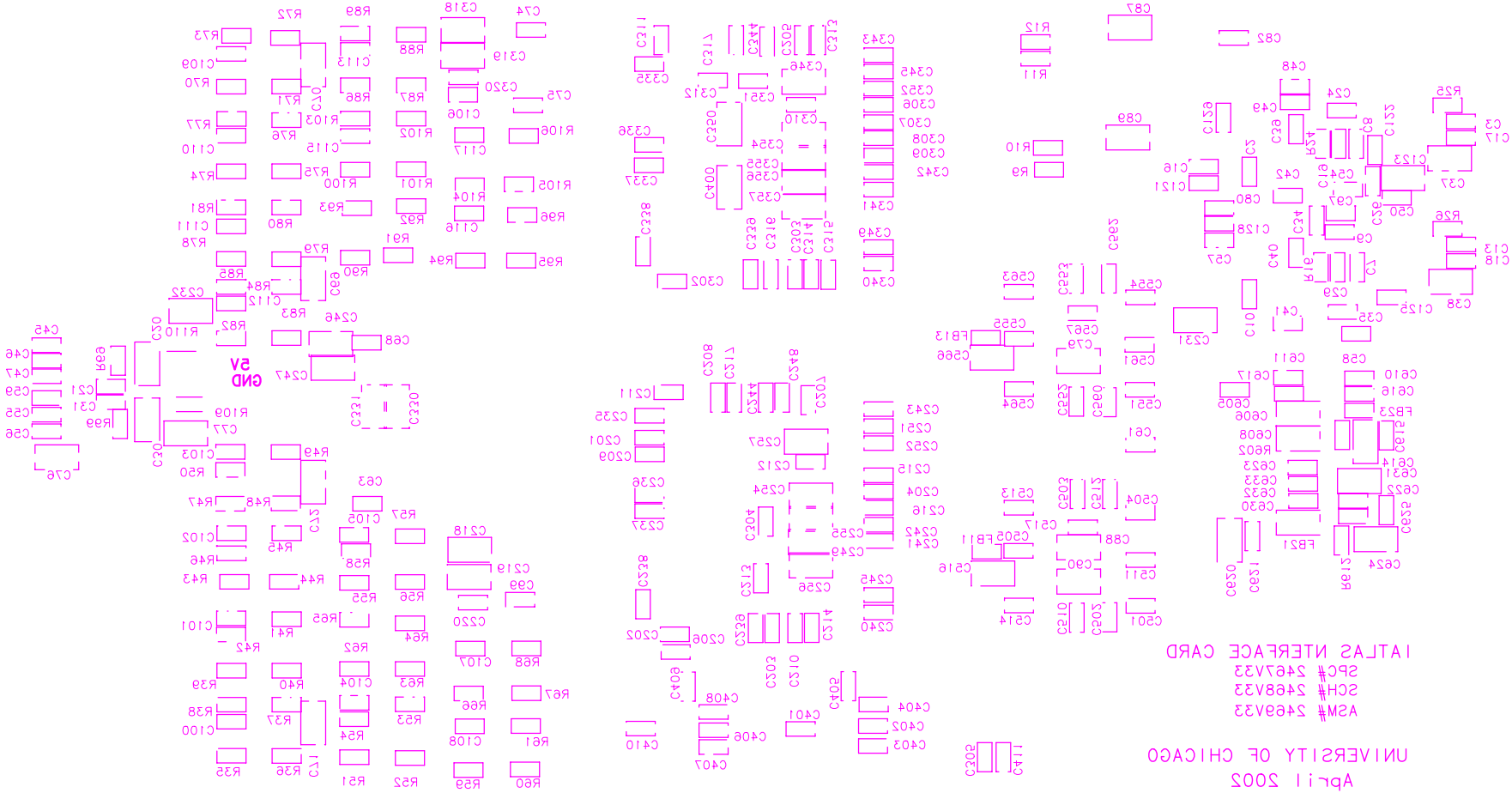


Artwork_11: Power_3 (VCC18B)

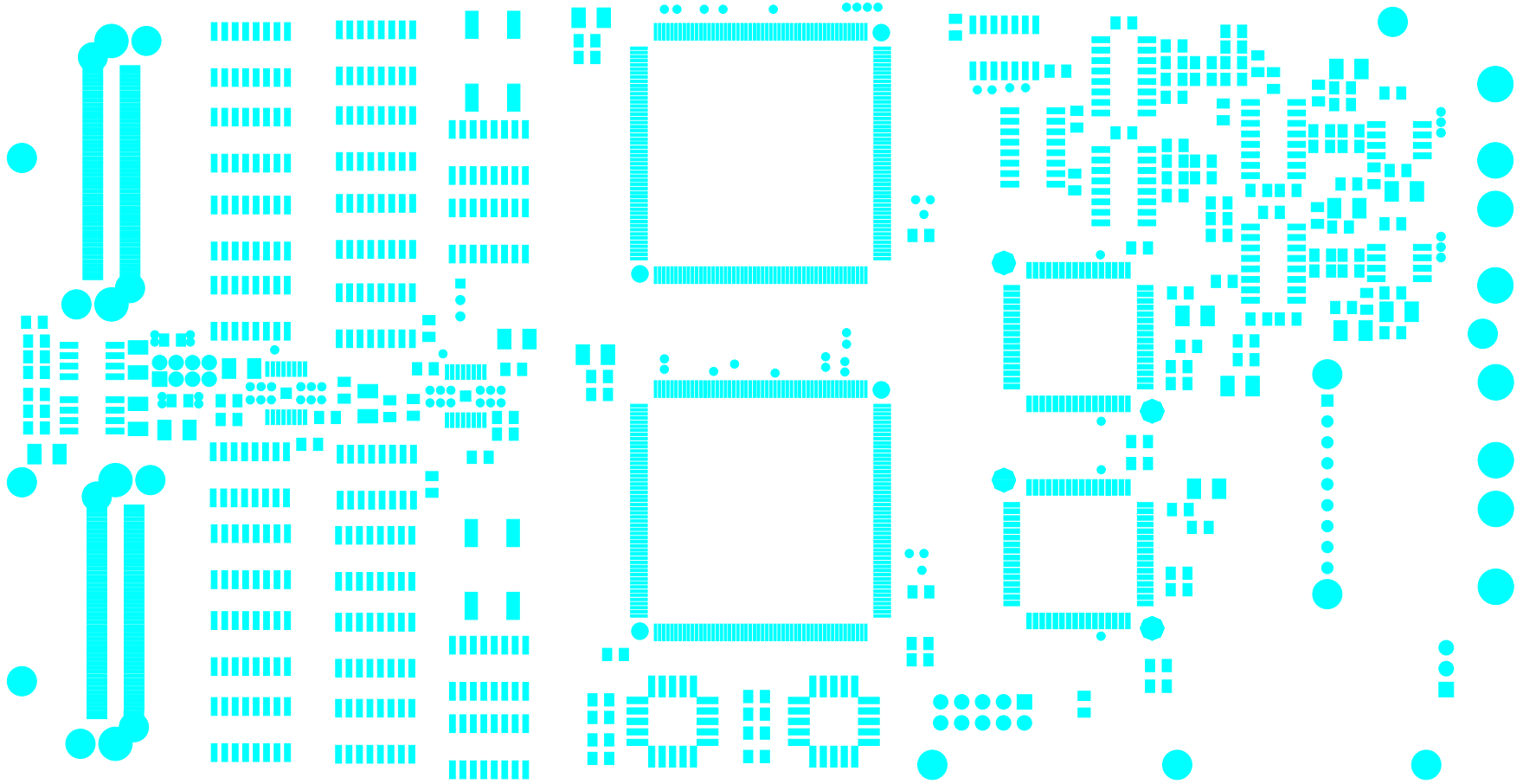


Artwork_12: Bottom component layer (SIGNAL_6)

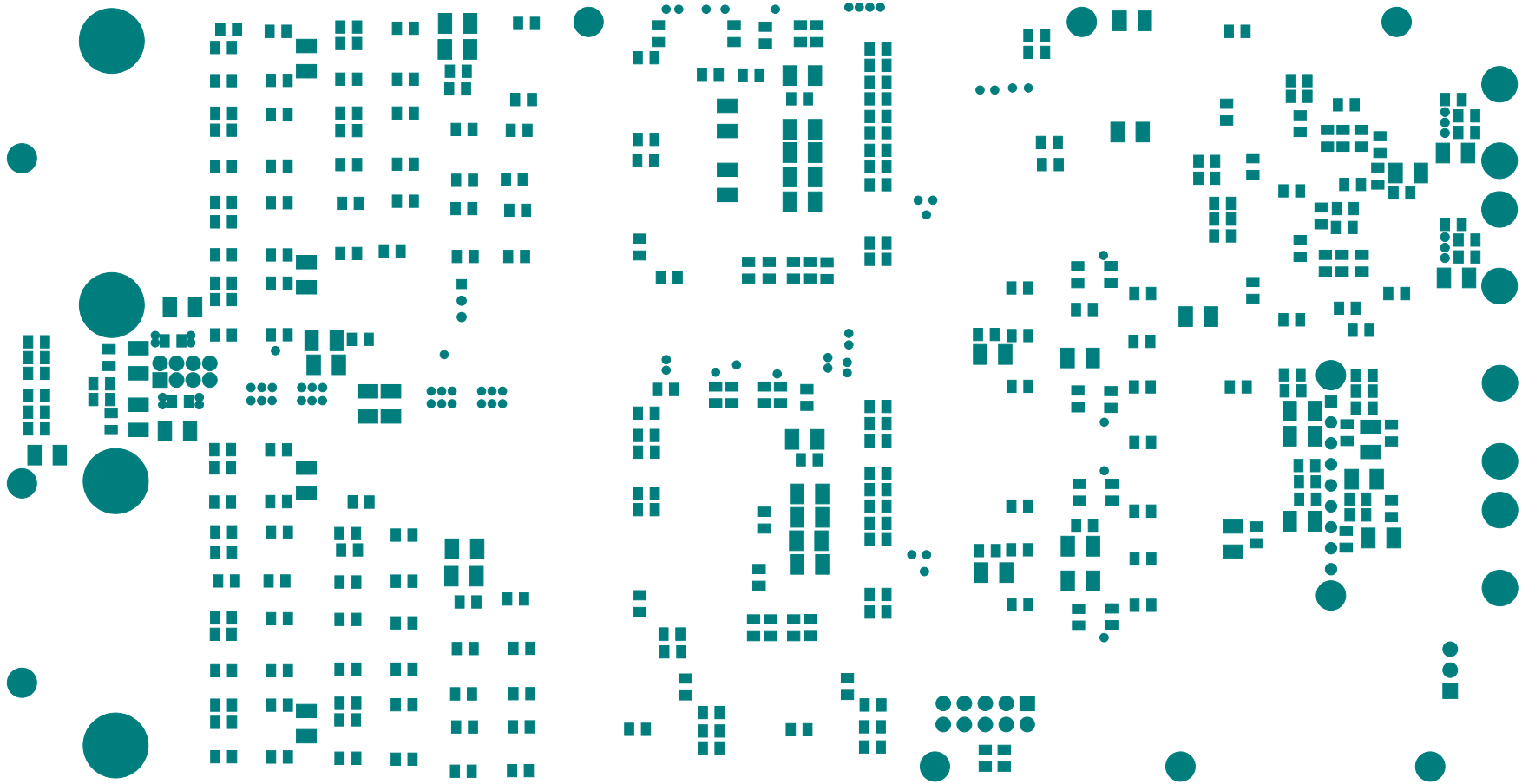
Artwork_13: Top silkcreen



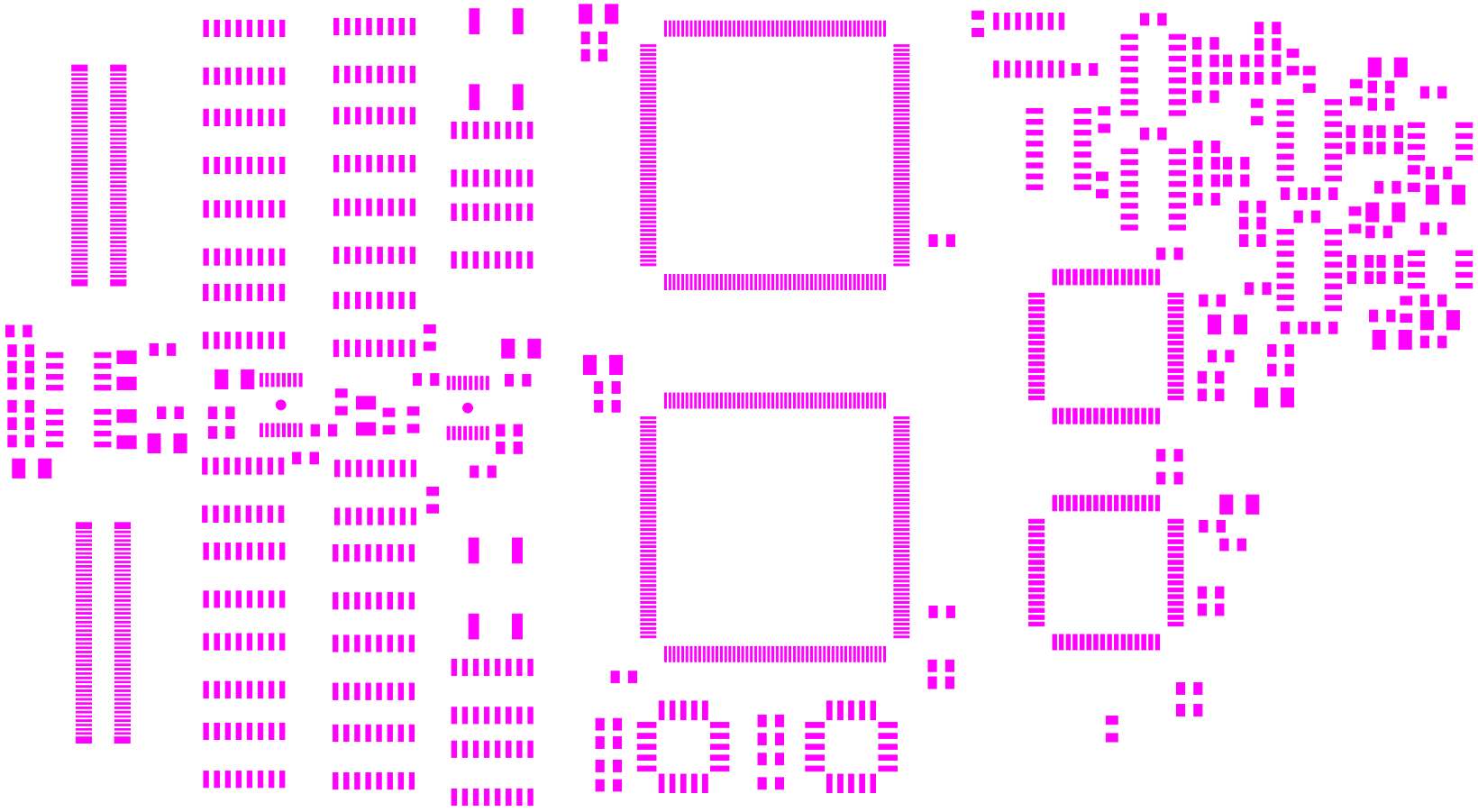
Artwork_14: Bottom silkscreen



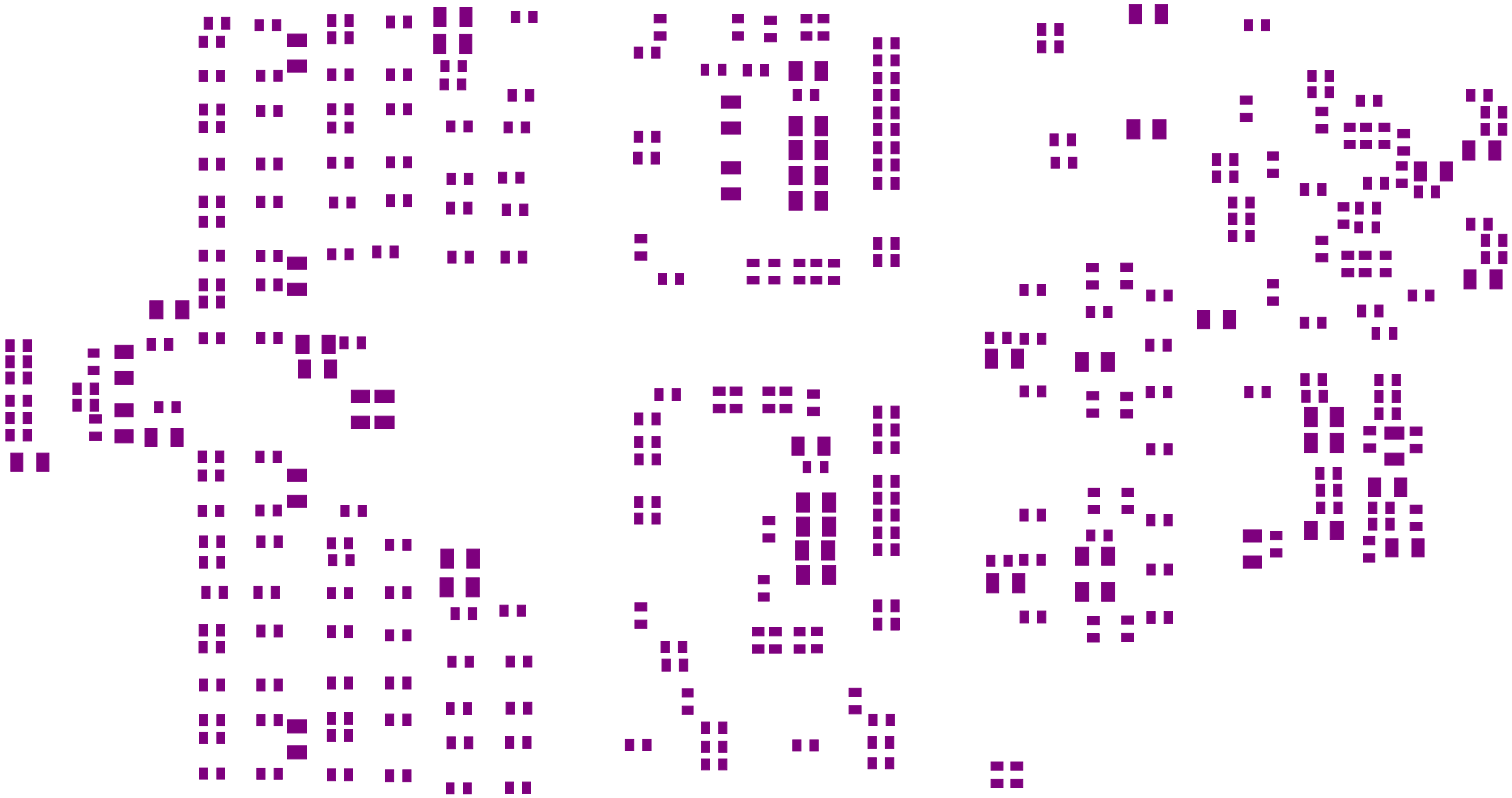
Artwork_15: Top solder mask



Artwork_16: Bottom solder mask

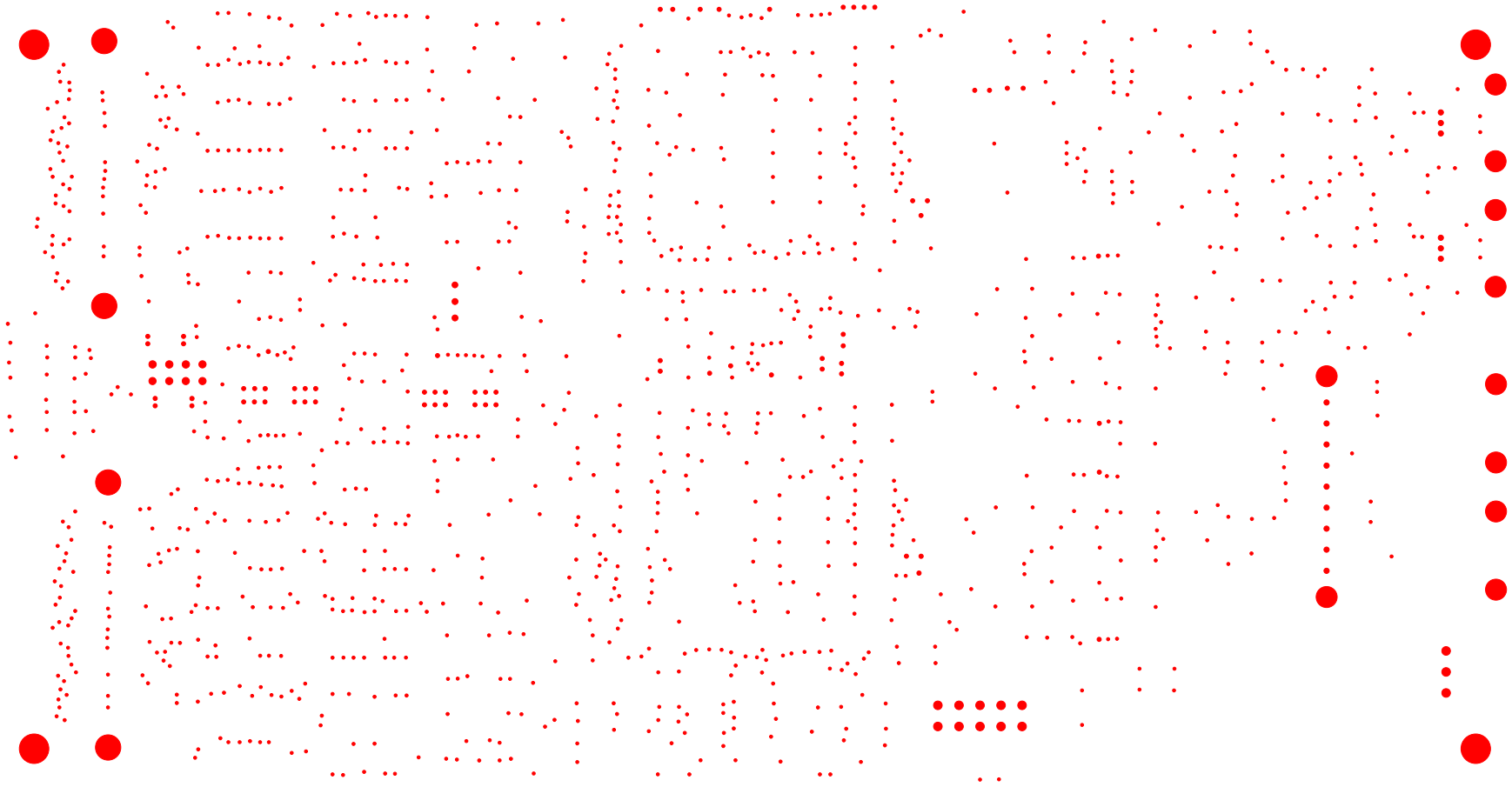


Artwork_17: Top paste mask



Artwork_18: Bottom paste mask

CAM350 V 7.0 : Mon Apr 15 13:48:16 2002 - 2468v33pcb.cam : 2468v33drl.dat



CAM350 V 7.0 : Mon Apr 15 13:48:16 2002 - 2468v33pcb.cam : 2468v33mil.dat